

## PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

## CONVEYING PARTY DATA

Name	Execution Date
GREG BRAECKELMANN	04/21/2008
MARIUS ORLOWSKI	04/21/2008
ANDREAS WILD	06/09/2008

## RECEIVING PARTY DATA

Name:	FREESCALE SEMICONDUCTOR INC.
Street Address:	6501 WILLIAM CANNON DRIVE WEST
City:	AUSTIN
State/Country:	TEXAS
Postal Code:	78735

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12936113

## CORRESPONDENCE DATA

Fax Number: (512)996-6854

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

Phone: 5129966839

Email: USADOCKETING@FREESCALE.COM

Correspondent Name: FREESCALE SEMICONDUCTOR, INC. LAW DEPART

Address Line 1: 7700 WEST PARMER LANE MD:TX32/PL02

Address Line 4: AUSTIN, TEXAS 78729

ATTORNEY DOCKET NUMBER:

MT10887CF

NAME OF SUBMITTER:

ROSEMARY HOFFERT

Total Attachments: 8

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## ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **BRAECKELMANN Greg, GRENOBLE, FRANCE, ORLOWSKI MARIUS, MEYLAN, FRANCE and WILD ANDREAS, TEMPE - ARIZONA, USA** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **METHOD OF SEALING AN AIR GAP IN A LAYER OF A SEMICONDUCTOR STRUCTURE AND SEMICONDUCTOR STRUCTURE** (Docket No. MT10887CF-USA), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the

inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

Braeckelmann DATE: 4/21/08  
BRAECKELMANN Greg

**First Witness**

Volker Tiedler DATE: 4/21/08  
SIGNATURE OF WITNESS (Month-Day-Year)

Volker Tiedler  
PRINTED NAME OF WITNESS

**Second Witness**

Karl Kocbinger DATE: 4/21/08  
SIGNATURE OF WITNESS (Month-Day-Year)

KARL KOCBINGER  
PRINTED NAME OF WITNESS

Marius Orłowski  
ORLOWSKI MARIUS

DATE: April 21, 2008

First Witness

Nancy Hall  
SIGNATURE OF WITNESS

DATE: 4/21/08  
(Month-Day-Year)

Mark Hall  
PRINTED NAME OF WITNESS

Second Witness

Brian G. Anthony  
SIGNATURE OF WITNESS

DATE: 4-21-08  
(Month-Day-Year)

Brian G. Anthony  
PRINTED NAME OF WITNESS

\_\_\_\_\_  
WILD ANDREAS

DATE: \_\_\_\_\_

**First Witness**

\_\_\_\_\_  
SIGNATURE OF WITNESS

DATE: \_\_\_\_\_  
(Month-Day-Year)

\_\_\_\_\_  
PRINTED NAME OF WITNESS

**Second Witness**

\_\_\_\_\_  
SIGNATURE OF WITNESS

DATE: \_\_\_\_\_  
(Month-Day-Year)

\_\_\_\_\_  
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We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

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inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

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\_\_\_\_\_  
BRAECKELMANN Greg

DATE: \_\_\_\_\_

**First Witness**

\_\_\_\_\_  
SIGNATURE OF WITNESS

DATE: \_\_\_\_\_  
(Month-Day-Year)

\_\_\_\_\_  
PRINTED NAME OF WITNESS

**Second Witness**

\_\_\_\_\_  
SIGNATURE OF WITNESS

DATE: \_\_\_\_\_  
(Month-Day-Year)

\_\_\_\_\_  
PRINTED NAME OF WITNESS



\_\_\_\_\_  
ORLOWSKI MARIUS                      DATE: \_\_\_\_\_

<b><u>First Witness</u></b>	
_____ SIGNATURE OF WITNESS	DATE: _____ (Month-Day-Year)
_____ PRINTED NAME OF WITNESS	

<b><u>Second Witness</u></b>	
_____ SIGNATURE OF WITNESS	DATE: _____ (Month-Day-Year)
_____ PRINTED NAME OF WITNESS	

AAW-8A  
WILD ANDREAS

DATE: June 9, 2008

**First Witness**

Cynthia Trigas  
SIGNATURE OF WITNESS

DATE: 06-09-2008  
(Month-Day-Year)

CYNTHIA TRIGAS  
PRINTED NAME OF WITNESS

**Second Witness**

Renate Moteira  
SIGNATURE OF WITNESS

DATE: 06-09-2008  
(Month-Day-Year)

Renate Moteira  
PRINTED NAME OF WITNESS